

RS-WC-201

Datasheet

Version 2.02

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Redpine Signals, Inc.

2107 N. First Street, #680 San Jose, CA 95131. Tel: (408) 748-3385 Fax: (408) 705-2019

Email: info@redpinesignals.com
Website: www.redpinesignals.com



The RS-WC-201 module is a complete IEEE 802.11b/g/n wireless device server that provides a wireless interface to any equipment with a UART, SPI or USB interface. The module integrates a MAC, baseband processor, RF transceiver with power amplifier; and all WLAN protocol and networking stack functionality in embedded firmware to make a fully self-contained 802.11n WLAN solution for a variety of applications. The module integrates an antenna and a U.FL connector for external antenna with an option to select either one of them.

Applications:

- Seamless Wi-Fi connectivity for Application Processors
- Industrial M2M communications
- Enterprise applications Wireless Printers, Point of Sale Terminals
- Security Cameras and Surveillance Equipment
- Medical applications Wireless Medical Instrumentation, Secure Patient Data Logging and Transfer
- Consumer applications- Wi-Fi connectivity to smart-phones and Tablet PCs using Wi-Fi Direct™ in devices such as Refrigerators, Washing Machines, Audio/Video Equipment, Digital Picture Frames etc.

Device Features:

- 802.11b/g and single stream 802.11n module
- Wi-Fi Direct™
- Access Point with WPA2-PSK security
- Client Mode with with WPA/WPA2-PSK and Enterprise Security
 - WPA/WPA2-Enterprise (EAP-TLS, EAP-FAST, EAP-TTLS, PEAP-MS-CHAP-V2)
- Integrated TCP, UDP, DNS client, ICMP, IGMP and DHCP Server
- HTTP Server and Client
- DNS Client
- 802.11d
- WPS (Wi-Fi Protected Setup) for ease of provisioning
- UART, SPI and USB interfaces
- Upgrade firmware wirelessly
- Integrated antenna, frequency reference and low-frequency clock
- Ultra low-power operation with power save modes
- Single supply 3.1 to 3.6V operation
- Dimensions 35mm X 22mm X 2.75mm



RS-WC-201 System Architecture

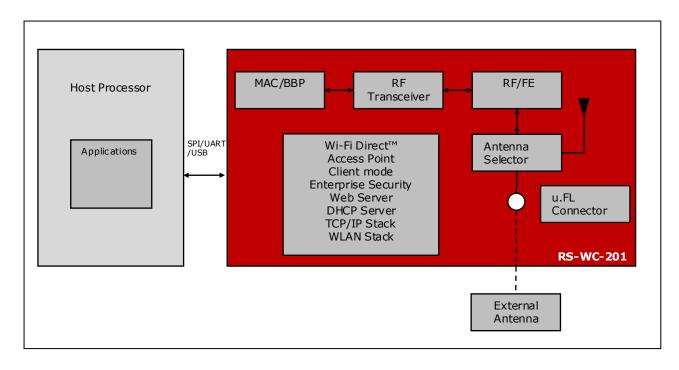




Table of Contents

	-201	
1 Deta	ailed Feature List	7
1.1	Host Interfaces	7
1.2	WLAN	7
1.3	Security	7
1.4	Wi-Fi Direct™	8
1.5	Access Point	8
1.6	HTTP Server	8
1.7	HTTP Client	8
1.8	Software and Documentation	8
2 Pacl	kage Description	9
2.1	Top View	9
2.2	Module Dimensions	
2.3	Pin Description	11
2.4	Recommended Reflow Profile	15
2.5	Baking Instructions	15
3 Elec	trical Characteristics	16
3.1	Absolute Maximum Ratings	16
3.2	Recommended Operating Conditions	
3.3	DC Characteristics - Digital I/O Signals	16
3.4	AC Characteristics - Digital I/O Signals	
3.4.1		
3.5	Reset Timing	18
4 Perf	formance Specifications	19
4.1	Wireless Specifications	19
4.2	Receive Sensitivity	19
4.3	Standards Compliance	19
4.4	Throughput	20
5 Soft	ware Architecture Overview	21
5.1	Host	22
5.2	RS-WC-201	22
5.2.1		
5.2.2	•	
	USB	
5.2.4	, , ,	
5.2.5 5.2.6	· ,	
5.2.7		
5.2.8		
5.3	Power Save	
6 Ord	ering Information	
6.1	Contact Information	
6.2	Device Ordering Information	
6.3	Software and Documentation	



Table of Figures

Figure 1: RS-WC-201 Module	9
Figure 2: Module Dimensions	
Figure 3: Reflow Profile	
Figure 4: Interface Timings – SPI	
Figure 5: Reset Pin Timing Diagram	
Figure 6: RS-WC-201 Software Architecture Block Diagram	



List of Tables

Table 1: Pin Description	14
Table 2: Absolute Maximum Ratings	
Table 3: Recommended Operating Conditions	
Table 4: Input/Output DC Characteristics	
Table 5: AC Characteristics – SPI Interface	
Table 6: Wireless Specifications	
Table 7: Receive Characteristics – Sensitivity	
Table 8: Throughput	
Table 9: Power Consumption	
Table 10: Device Ordering Information	



1 Detailed Feature List

1.1 Host Interfaces

- UART
 - AT Command Interface supported for configuration and module operation
 - Baud-rate of 115200 bps supported currently. Support for higher baud rates are planned in future firmware releases
- SPI
 - Standard 4-wire SPI
 - Operation up to a maximum clock speed of 12.5MHz¹
- USB 2.0
 - The USB interface in the module corresponds to the CDC-ACM class and presents itself as a USB Device to the Host USB.

1.2 WLAN

MAC

- IEEE 802.11b/g/n standard
- Dynamic selection of data rate depending on the channel conditions
- Hardware accelerated implementation of AES
- Wi-Fi Direct, Access Point and Client modes

Baseband Processing

- Supports DSSS (1, 2 Mbps) and CCK (5.5, 11 Mbps) modes
- Supports all OFDM data rates (6 Mbps to 54 Mbps in 802.11g and MCS0 to MCS7 in 802.11n mode)
- Supports long, short, and HT preamble modes
- High-performance multipath compensation in OFDM, DSSS, and CCK modes

RF

- 2.4 GHz transceiver and Power Amplifier with direct conversion architecture
- Integrated frequency reference and antenna

1.3 Security

• WPA/WPA2-Enterprise (supported when the module is configured in Client mode).

¹ This frequency depends on the external delays also.



- EAP-TLS
- o EAP-TTLS
- EAP-FAST
- o PEAP-MS-CHAP-V2
- WPA/WPA2-PSK
- WPS-Push Button Support

1.4 Wi-Fi Direct™

The module supports Wi-Fi Direct™. Wi-Fi Direct enables two Wi-Fi devices to communicate directly, without an access point in between. RS-WC-201 can act as a Wi-Fi Direct Group Owner, so that Wi-Fi Direct Peerto-Peer nodes can join and exchange data. The module can also connect as a Peer-to-Peer client to another Wi-Fi Direct Group Owner (GO) node. Legacy Wi-Fi (non Wi-Fi Direct) nodes can also connect to the module.

1.5 Access Point

The module has an embedded Access Point. It supports four clients when in Access Point mode, and also acts as a DHCP server. WPA2-PSK security is supported. All standard Wi-Fi devices like Laptops, Smart-phones and Tablet PCs can connect to the Access Point. The connected clients can go to power save during this mode.

1.6 HTTP Server

The module hosts an HTTP server. It provides memory space where HTML pages can be loaded. The module implements the server back end and responds to HTTP Get or HTTP Post requests from the remote terminal. The remote terminal can access the web pages through a standard web browser.

1.7 HTTP Client

The module can act as a HTTP client and can be configured to send HTTP GET and HTTP POST requests to a remote HTTP server, and also receive the responses and forward to the Host.

1.8 Software and Documentation

The following are provided with the Wi-Fi modules

- Programming Reference Manual that contains descriptions of all commands to control and operate the module
- Reference schematics for module's integration with application board.
- Sample Host driver source code for SPI interface
- Sample applications and Evaluation Board User Guide for evaluating functionality of the module



2 Package Description

2.1 Top View



Figure 1: RS-WC-201 Module



2.2 Module Dimensions

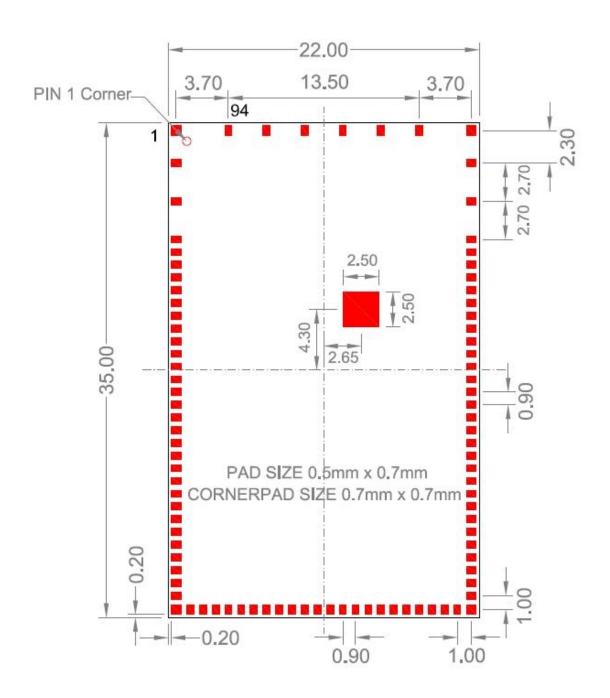


Figure 2: Module Dimensions

Package Type: LGA

Module height: 2.75 +/- 0.05 mm



2.3 Pin Description

Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC - No connect No connect	Pin No	Pin Name	Directi on	Туре	Description
3 NC No connect 4 USB_VREGIN Power - 5V power supply for USB transceiver. No connect when USB not used 5 GND Ground 6 VCC3.3 Power - 3.3V Power Supply 7 VCC3.3 Power - 3.3V Power Supply 8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC No connect 11 JPD2 Connect pull down of 1 kOhms 12 JPD1 Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output J./O, 9mA Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC - No connect 16 NC - No connect 17 NC - No connect 18 GND - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA UKAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be grounded 20 BT_PRIORITY Input LVCMOS , 2mA light priority traffic. Not used in current firmware, should be grounded 21 NC Ro connect 22 GND Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	1	GND	Ground	-	Ground
4 USB_VREGIN Power - SV power supply for USB transceiver. No connect when USB not used 5 GND Ground 6 VCC3.3 Power - 3.3V Power Supply 7 VCC3.3 Power - 3.3V Power Supply 8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC No connect 11 JPD2 Connect pull down of 1 kOhms 12 JPD1 Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC No connect 16 NC No connect 17 NC No connect 18 GND Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA Used for BT Coexistence. It indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be grounded 20 BT_PRIORITY Input LVCMOS , 2mA Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC Roconnect 22 GND Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	2	GND	Ground	-	Ground
transceiver. No connect when USB not used 6 VCC3.3 Power - 3.3V Power Supply 7 VCC3.3 Power - 3.3V Power Supply 8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC - No connect 11 JPD2 - Connect pull down of 1 kOhms 12 JPD1 - Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC - No connect 16 NC - No connect 17 NC - No connect 18 GND - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be grounded 20 BT_PRIORITY Input LVCMOS , 2mA indicates with Indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - Ground 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	3	NC	-	-	No connect
6 VCC3.3 Power - 3.3V Power Supply 7 VCC3.3 Power - 3.3V Power Supply 8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC - No connect 11 JPD2 - Connect pull down of 1 kOhms 12 JPD1 - Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input J/O, firmware upgrade. Should be 9mA connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output J/O, 9mA enceted to a GPIO pin of the Host MCU 15 NC - No connect 16 NC - No connect 17 NC - No connect 18 GND - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be grounded 20 BT_PRIORITY Input LVCMOS , 2mA high priority traffic. Not used in current firmware, should be grounded 21 NC - Ro Connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	4	USB_VREGIN	Power	-	transceiver. No connect when
7 VCC3.3 Power - 3.3V Power Supply 8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC - No connect 11 JPD2 - Connect pull down of 1 kOhms 12 JPD1 - Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC - No connect 16 NC - No connect 17 NC - No connect 18 GND - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	5	GND	-	-	Ground
8 VCC3.3 Power - 3.3V Power Supply 9 JPD0 Connect pull down of 1 kOhms 10 JNC No connect 11 JPD2 Connect pull down of 1 kOhms 12 JPD1 Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC - No connect 16 NC - No connect 17 NC - No connect 18 GND - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - Ground 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	6		Power	-	3.3V Power Supply
9 JPD0 Connect pull down of 1 kOhms 10 JNC No connect 11 JPD2 Connect pull down of 1 kOhms 12 JPD1 Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless 1/O, firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC No connect 16 NC No connect 17 NC - No connect 18 GND Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC Ro connect 22 GND Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	7	VCC3.3	Power	-	3.3V Power Supply
10	8	VCC3.3	Power	-	3.3V Power Supply
11	9	JPD0	-	-	Connect pull down of 1 kOhms
12 JPD1 Connect pull down of 1 kOhms 13 WF_HNDSHKE1 Input 3.3V Handshake signal for wireless firmware upgrade. Should be connected to a GPIO pin of the Host MCU 14 WF_HNDSHKE2 Output 3.3V Handshake signal for wireless I/O, firmware upgrade. Should be connected to a GPIO pin of the Host MCU 15 NC No connect 16 NC No connect 17 NC No connect 18 GND Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA WLAN_ACTIVE indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA when low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA when low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	10	JNC	-	-	No connect
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17 NC - Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA ULAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA bigh priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	15	NC	-	-	No connect
18 GND Ground 19 WLAN_ACTIVE Output LVCMOS , 2mA Used for BT Coexistence. It indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS , 2mA high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC No connect 22 GND Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	16	NC	-	-	No connect
19 WLAN_ACTIVE Output LVCMOS , 2mA Used for BT Coexistence. It indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	17	NC	-	-	No connect
, 2mA indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open 20 BT_PRIORITY Input LVCMOS Used to indicate through logic high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	18	GND	-	-	Ground
, 2mA high that BT is transmitting high priority traffic. Not used in current firmware, should be grounded 21 NC - No connect 22 GND - Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).			·	, 2mA	indicates with logic high that WLAN activity is in progress. When low, BT device has the opportunity to transmit. Not used in current firmware, should be left open
22 GND Ground 23 USB_DP Input 3.3V I/O USB differential pin (Positive).	20		Input		high that BT is transmitting high priority traffic. Not used in current firmware, should be
23 USB_DP Input 3.3V I/O USB differential pin (Positive).	21	NC	-	-	No connect
	22	GND		-	
should be left open	23	USB_DP	Input	3.3V I/O	Not used in current firmware,
24 USB_DM Input 3.3V I/O USB differential pin	24	USB_DM	Input	3.3V I/O	



				(Negative). No connect if USB is not used
25	PT_GPIO1	Output	3.3V I/O,	Pass through output pin controllable by Host software.
			2mA	
26	PT_GPIO2	Output	3.3V	Pass through output pin
			I/O,	controllable by Host software.
			2mA	
27	TP1	-	-	Test point
28	TP2	-	-	Test point
29	TP3	-	-	Test point
30	TP4	-	-	Test point
31	TP5	-	-	Test point
32	NC	-	-	No connect
33	GND	-	-	Ground
34	NC	-	-	No Connect.
35	NC	-	-	No connect
36	NC	-	-	No connect
37	NC	-	-	No connect
38	NC	-	-	No connect
39	NC	-	-	No connect
40	NC	-	-	No connect
41	NC	-	-	No connect
42	NC	-	-	No connect.
43	RESET_N	Input	3.3V I/O	Active low reset for the
				module
44	GND	-	-	Ground
45	MODE_SEL_2	Input	3.3V I/O	Interface selection Bit[2]
46	MODE_SEL_1	Input	3.3V I/O	Interface selection Bit[1]
47	MODE_SEL_0	Input	3.3V I/O	Interface selection Bit[0]
				Module interface Selection:
				Bit[2],Bit[1],Bit[0] = '000' for selecting UART interface
				Bit[2],Bit[1],Bit[0] = '001' for selecting SPI interface
				Bit[2], Bit[1], Bit[0] = '010' for selecting USB interface
48	WIFI_ACTIVITY	Output	3.3V I/O	Wi-Fi Activity indicator. This pin is '0' when the module is transferring data.
49	CARD_READY	Output	3.3V I/O	Card ready indicator. Logic '0' indicates successful boot-up of the module
50	GND	Ground	-	Ground



E1	NC		1	No connect
51			-	No connect
52	NC	-	-	No connect
53	NC	-	-	No connect
54	NC	-	-	No connect
55	ADC2	Input	3.3V I/O	Analog input to internal ADC. Not used in current firmware, should be left open
56	GND	Ground	-	Ground
57	ADC1	Input	3.3V I/O	Analog input to internal ADC. Not used in current firmware, should be left open
58	WAKEUP	Input	3.3V I/O	The module wakes up from sleep if logic high is driven into this pin. Used only in SPI mode, should be left open in UART mode.
59	SPI_READY	Output	3.3V I/O, 2mA	Handshake signal used in SPI mode and connected to a GPIO pin of the Host MCU. In other modes, this pin can be left open
60	UART_RTS	Output	3.3V I/O, 2mA	UART Request to Send. Not used in current firmware, should be left open
61	UART_CTS	Input	3.3V I/O	UART Clear to Send. Not used in current firmware, should be left open
62	UART_TX	Output	3.3V I/O, 2mA	UART- Transmit
63	UART_RX	Input	3.3V I/O	UART - Receive
64	INTR	Output	3.3V I/O, 2mA	Active high, level triggered interrupt. Used in SPI mode. The interrupt is raised by the module to indicate there is data to be read by the Host, or to indicate the module has woken up from sleep. In UART mode, it can be left open
65	SPI_CS	Input	3.3V I/O	SPI slave select
66	SPI_CLK	Input	3.3V I/O	SPI clock input
67	SPI_MISO	Output	3.3V I/O, 2mA	SPI data output
68	SPI_MOSI	Input	3.3V I/O	SPI data input
69	GND	-	-	Ground
70	PA_EN	Output	LVCMOS , 4mA	External PA enable. If an external Power Amplifier is used, this should be connected to the enable of the external



				PA. Not used in current
				firmware, should be left open
71	NC	-	-	No connect
72	NC	-	-	No connect
73	NC	-	-	No connect
74	NC	-	-	No connect
75	NC	-	-	No connect
76	NC	-	-	No connect
77	USB_ID	Input	3.3V I/O	Device/Host mode sense (OTG Mode). No connect if USB OTG not used
78	GND	-	-	Ground
79	NC	-	-	No connect
80	NC	-	-	No connect
81	USB_LDO_FLAG	Input	3.3V	Power distribution IC Health
			I/O, 2mA	Monitor (OTG Mode). Not used in current firmware, should be left open
82	NC	-	-	No connect
83	PD	-	-	Connect pull down of 4.7K Ohms
84	GND	-	-	Ground
85	USB_LDO_EN	Output	3.3V I/O, 2mA	Power Distribution IC Enable (OTG Mode). Not used in current firmware, should be left open
86	NC	-	-	No connect
87	NC	-	-	No connect
88	NC	-	-	No connect
89	NC	-	-	No connect
90	NC	-	-	No connect
91	NC	-	-	No connect
92	NC	-	-	No connect
93	GND	-	-	Ground
94	GND	-	-	Ground
95	GND PAD	-	-	Thermal Ground Pad
		-		

Table 1: Pin Description

Notes: The reference schematics showing pin connections for the module are present in the Module Integration Guide document. The document can be requested from Redpine Signals. Some pins are not used in the default configuration or mode of operation. These may be used in custom applications with appropriate firmware.



2.4 Recommended Reflow Profile

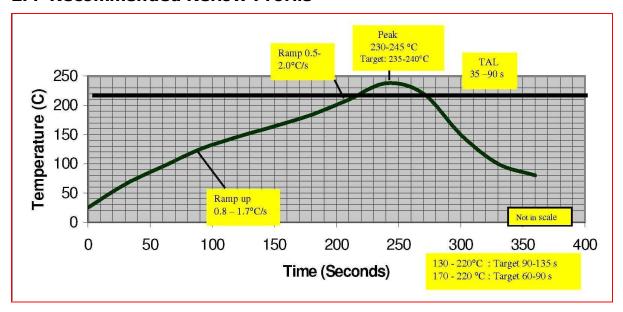


Figure 3: Reflow Profile

NOTE: The profile shown is based on SAC 305 solder (96.5% Tin, 3% silver, 0.5% copper). We recommend the ALPHA OM-338 lead-free solder paste. This profile is provided mainly for guidance. The total dwell time depends on the thermal mass of the assembled board and the sensitivity of the components on it.

2.5 Baking Instructions

The RS-WC-201 package is compliant to MSL-3. It is a moisture sensitive device and must be handled appropriately. After the devices are removed from their vacuum sealed packs, they should be taken through reflow for board assembly within 168 hours during which time, they are expected to be stored at MSL-3 environmental conditions (less than 60% relative humidity and 30° C). If these conditions are not met, the devices must be baked before reflow. The recommended baking time is nine hours at 125° C.



3 Electrical Characteristics

3.1 Absolute Maximum Ratings

Absolute maximum ratings in the table given below are the values beyond which the device could be damaged. Functional operation at or beyond these conditions is not guaranteed.

Parameter	Symbol	Value	Units
Input Supply voltage	Vin	3.6	V
Supply voltage for I/O Rail	DVDD33	3.6	V
Supply Voltage for the RF	VRF33	3.6	V
RF Input Level	RFIN	10	dBm
Storage temperature	T _{store}	-65 to 150	°C
Electrostatic discharge tolerance (HBM)	ES D _{HBM}	2000	V
Electrostatic discharge tolerance (MM)	ES D _{MM}	200	V
Electrostatic discharge tolerance (CDM)	ES D _{CDM}	500	V

Table 2: Absolute Maximum Ratings

3.2 Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Units
Input Supply voltage	V_{DD}	3.1	3.3	3.6	V
Ambient temperature	Ta	-40	25	85	°C
Peak source current for Power Supply design ²		-	-	400	mA

Table 3: Recommended Operating Conditions

3.3 DC Characteristics - Digital I/O Signals

Parameter	Min.	Тур.	Max.	Units
Input high voltage	2.2	-	3.6	V
Input low voltage	-0.3	-	0.8	V
Output low voltage	-	-	0.5	V
Output high voltage	2.6	-	-	V

 $^{^{\}rm 2}$ For information on power consumption in functional modes, please contact Redpine Signals.



Parameter	Min.	Тур.	Max.	Units
Input leakage current (at 3.3V or 0V)	-	-	1	μΑ
Hi-Z (off-state) leakage current (per pin)	-	-	1	μΑ

Table 4: Input/Output DC Characteristics

3.4 AC Characteristics – Digital I/O Signals

3.4.1 SPI Interface

Parameter	Symbol	Min.	Max.	Units
SPI_CLK Frequency	Fspi	0	12.5	MHz
SPI_CLK high/low time	DS10	(Tspi ³ /2)-2	(Tspi/2)+2	ns
SPI_CLK to SPI_MISO valid	DS11	-	10	ns
SPI_CLK to SPI_MISO invalid	DS12	0	-	ns
SPI_MOSI to SPI_CLK setup	DS13	2	-	ns
SPI_CLK to SPI_MOSI hold	DS 14	7	-	ns
SPI_CS active to SPI_MISO driven	DS 15	-	14	ns
SPI_CS inactive to SPI_MISO not driven	DS16	-	14	ns

<u>Table 5: AC Characteristics - SPI Interface</u>

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³ Time period corresponding to Frequency Fspi



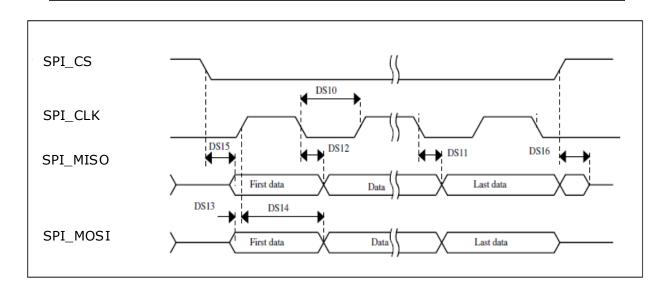


Figure 4: Interface Timings - SPI

3.5 Reset Timing

Following diagram shows the timing requirement for Reset input in two scenarios.

- A. Power up
- B. Giving hard reset during module operation

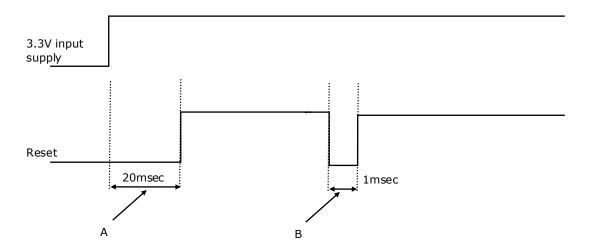


Figure 5: Reset Pin Timing Diagram



4 Performance Specifications

4.1 Wireless Specifications

Feature	Description
Frequency Band	2.400 - 2.500 GHz (2.4 GHz ISM band)
Modulation	OFDM with BPSK, QPSK, 16-QAM, and 64-QAM 802.11b with CCK and DSSS
Supported Data Rates	802.11n: 6.5, 13, 19.5, 26, 39, 52, 58.5 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps
802.11n Features	MCS 0-7, STBC, RIFS, A-MPDU, A-MSDU Aggregation with Block-ack
Typical Transmit Power (+/- 2 dBm)	17 dBm for 802.11b DSSS 17 dBm for 802.11b CCK 15 dBm for 802.11g/n OFDM

Table 6: Wireless Specifications

4.2 Receive Sensitivity

Data Rate	Typical Sensitivity (+/- 1.5 dBm)	Condition
1 Mbps	-97.0 dBm	PER < 8%
2 Mbps	-93.0 dBm	PER < 8%
11 Mbps	-88.0 dBm	PER < 8%
6 Mbps	-91.0 dBm	PER < 10%
54 Mbps	-75.0 dBm	PER < 10%
65 Mbps	-71.0 dBm	PER < 10%

<u>Table 7: Receive Characteristics - Sensitivity</u>

4.3 Standards Compliance

RS-WC-201 is compliant with the requirements of IEEE 802.11b, 802.11g and 802.11n that include the following:

- Transmit Spectral Mask
- Transmit Center Frequency Leakage
- Transmit Center Frequency Accuracy
- Receiver Adjacent Channel Interference Rejection
- Receiver Minimum Input Level



• Receiver Maximum Input Level

4.4 Throughput

Interface	Throughput
SPI (12.5 MHz SPI clock)	Tx - 4 Mbps (TCP) - 5.5 Mbps (UDP) Rx - 3.5 Mbps (TCP) - 5 Mbps (UDP)
UART (at 115200 bps)	Tx - 90 kbps (TCP, UDP) Rx - 75 kbps (TCP, UDP) ⁴

Table 8: Throughput

Throughput varies with the speed of the Host, the environment (that determines packet retransmissions) etc.

 $^{^{\}rm 4}$ Throughput for USB interface are being characterized, will be available in next revision



5 Software Architecture Overview

The following figure depicts the software architecture of the RS-WC-201 module.

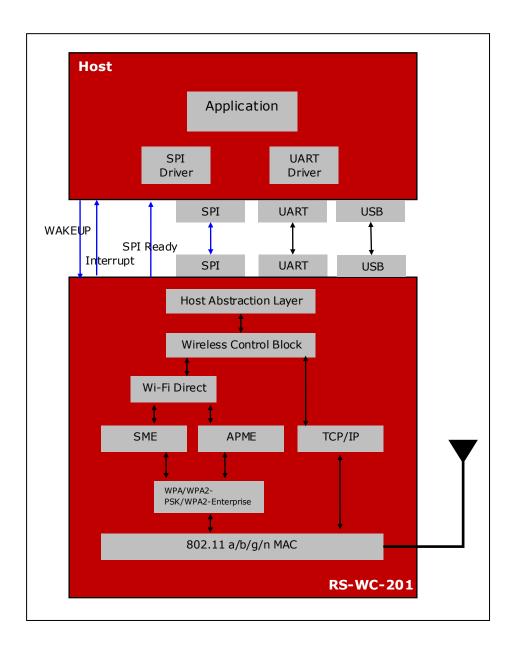


Figure 6: RS-WC-201 Software Architecture Block Diagram

As shown in the figure above, the RS-WC-201 module is integrated with the Host using the UART, SPI or USB interface. The module receives all configuration commands from the Host and transfers data to or receives data from the Host through this interface.



5.1 Host

The Host is any system that has applications being executed through a UART SPI or USB interface.

5.2 RS-WC-201

The RS-WC-201 module incorporates TCP/IP, DHCP, ARP, etc., to act as a wireless device server. It handles all the network connectivity functions. The following sections describe the components of the RS-WC-201 module.

5.2.1 SPI

The SPI on the RS-WC-201 module is one of the physical interfaces which transmits/receives the data to/from the Host. The SPI on the RS-WC-201 acts the SPI slave. It is a standard 4-wire SPI and can support a maximum frequency of 12.5 MHz.

5.2.2 **UART**

The UART on the RS-WC-201 module is one of the physical interfaces which transmits/receives the data to/from the Host. There is support for AT commands to configure and operate the module through UART interface.

5.2.3 USB

The USB2.0 on the RS-WC-201 module is the third physical interface which transmits/receives the data to/from the Host. The USB in the module acts as a USB device and corresponds to the CDC-ACM class. The USB interface of the module supports the full speed USB mode (12 Mbps physical data rate).

5.2.4 Host Abstraction Layer (HAL)

The HAL abstracts the lower layers in the host interface with which the RS-WC-201 module is connected. The HAL interacts with the Wireless Control Block layer for the processing of the frames obtained from or destined to the Host.

5.2.5 Wireless Control Block (WCB)

The data from/to the Host is classified as Wi-Fi specific frames and TCP/IP specific frames. The WCB layer processes the frame obtained and acts accordingly. The functionality of the WCB module depends on the type of the frame and the direction of the frame.

5.2.6 Station Management Entity (SME)

The SME is the core layer which manages the Wi-Fi connectivity. The SME maintains the state machine to detect the activity on the Wi-Fi network and indicates to the Host accordingly. It also performs re-association to the configured access point in Infrastructure mode. It interacts with the WPA supplicant if Security is enabled in the Wi-Fi network.

5.2.7 Access Point Management Entity (APME)

The APME is the core layer which manages the connectivity in Access Point mode. This mode is invoked in Wi-Fi Direct Group Owner mode or in Access Point mode. The APME maintains the state machine to handle multiple clients connected to the module.



5.2.8 WPA Supplicant

The WPA supplicant is used to initiate the 802.1x/EAP authentication. It also plays a major part in performing the 4-way handshake to derive the PTK in WPA/WPA2-PSK modes.

5.3 Power Save

The RS-WC-201 module is an ultra low power Wi-Fi module. The Host can select either an always-on mode or power save mode for the module. In power save mode, the module powers off the Baseband, RF and also the Core Control Block during the sleep intervals. There are three power save modes supported in the module:

Power Mode 1: This mode is based on a configurable internal timer. The module can be made to wake-up at periodic intervals, based on the timer configured by the Host.

Power Mode 2: In this mode, the module can be woken up from sleep by the Host at any time.

Power Mode 3: In this mode, the module can be set to shut down mode by the Host using a software command. When woken up by the Host, it initiates a boot-up sequence as if a fresh power up has happened. Power consumption is lowest in this mode. More detailed description of the power save modes is available in the Programming Reference Manual.

Some representative numbers for power consumption in specific scenarios are described below.

Power Save State	Value	Description	
Deep Sleep	2.3 mA	This is the state of the module when it is in sleep state in Power Mode 1 and 2.	
Continuous Tx	370 mA	Module transmitting data continuously at 54 Mbps physical data rate and 17dBm RF power	
Continuous Rx	226 mA	Module receiving data continuously	
Shut down	110 μΑ	This is the state of the module when it is set to shut down mode in Power Mode 3	

Table 9: Power Consumption



6 Ordering Information

6.1 Contact Information

For additional information, please contact Sales at Redpine Signals, Inc.

Redpine Signals, Inc.

2107 North First Street, Suite 680,

San Jose, CA 95131 USA Phone: +1 408 748 3385

E-mail: sales@redpinesignals.com

Website: http://www.redpinesignals.com/

6.2 Device Ordering Information

The following table lists the part numbers to be used for ordering modules or evaluation boards (EVB). Redpine can also provide customized firmware based on user requirements.

Device Number	Description	Packaging	Qualification
RS-WC-201	Module	Tray	-40 C to +85 C
RS-WC-201-EVB	Evaluation board	Board	

<u>Table 10: Device Ordering Information</u>

6.3 Software and Documentation

The following software and documentation are available along with the RS-WC-201.

- Embedded firmware for WLAN and TCP/IP stack
- APIs for all the supported interfaces
- Programming Reference Manual Describes the commands to control and operate the module
- Module Integration Guide Reference schematics and layout guidelines to integrate the module in the user's board
- Evaluation Board (EVB), EVB User Guide and demo applications to evaluate module functionalities
